BER: 00-C-015 September 7, 2000

Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor(s): Anthony M. Chiu

For: SURFACE MOUNT PACKAGE FOR LINEAR ARRAY SENSORS

Enclosed are:

- X Patent Specification and Declaration
- X 3 sheets of drawing(s).
- X An assignment of the invention to STMicroelectronics, Inc. (includes Recordation Form Cover Sheet).
- A certified copy of a \_ application.
- Information Disclosure Statement, PTO 1449 and copies of references.

The filing fee has been calculated as shown below:

For	Number Filed	Number Extra	Rate .	Fee
Basic Fee				\$690.00
Total Claims	18 - 20	0	x 18 =	\$ .00
Indep. Claims	4 - 3	1	x 78 =	\$ 78.00
MULTIPLE DEPENDENT	CLAIM PRESENTED		x 260 =	\$
			TOTAL	\$768.00

- X Enclosed please find our checks in the amounts of \$768.00 and \$40.00.
- X The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account <u>06-0580</u>. A duplicate copy of this sheet is enclosed.
- X Any additional filing fees required under 37 CFR §1.16.
- X Any patent application processing fees under 37 CFR §1.17.

**CERTIFICATE OF EXPRESS MAILING UNDER 37 CFR § 1.10** 

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I hereby certify that the documents indicated above are being deposited with the United States Postal Service under 37 CFR 1.10 on the date indicated above and are addressed to Box Patent Applications, Assistant Commissioner for Patents, Washington, D.C. 20231 and mailed on the above Date of Mailing with the above "Express Mail" mailing label number.

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Respectfully submitted,

Dan Yenglarik

Registration No. 39,409 for

FELSMAN, BRADLEY, VALVEN,

**GUNTER & DILLON, LLP** 

201 Main Street, Suite 1600

Fort Worth, Texas 76102

Telephone (817) 332-8143